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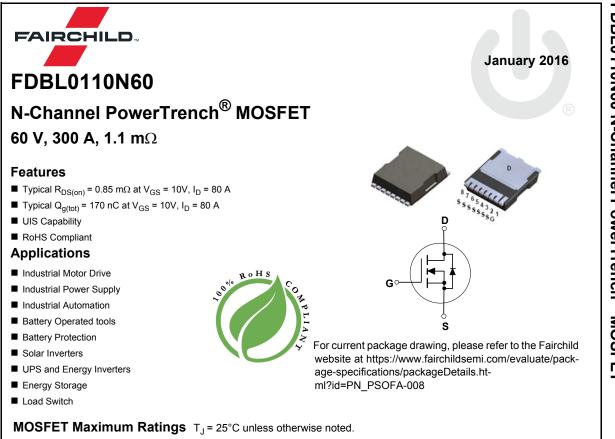


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-to-Source Voltage		60	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	300	^
I _D	Pulsed Drain Current	T _C = 25°C	See Figure 4	— A
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	1167	mJ
D	Power Dissipation		429	W
P _D	Derate Above 25°C		2.86	W/ºC
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.35	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W

Notes:

1: Current is limited by bondwire configuration.

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FDBL0110N60 Rev.1.2

2: Starting T_J = 25°C, L = 0.57mH, I_{AS} = 64A, V_{DD} = 40V during inductor charging and V_{DD} = 0V during time in avalanche. 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

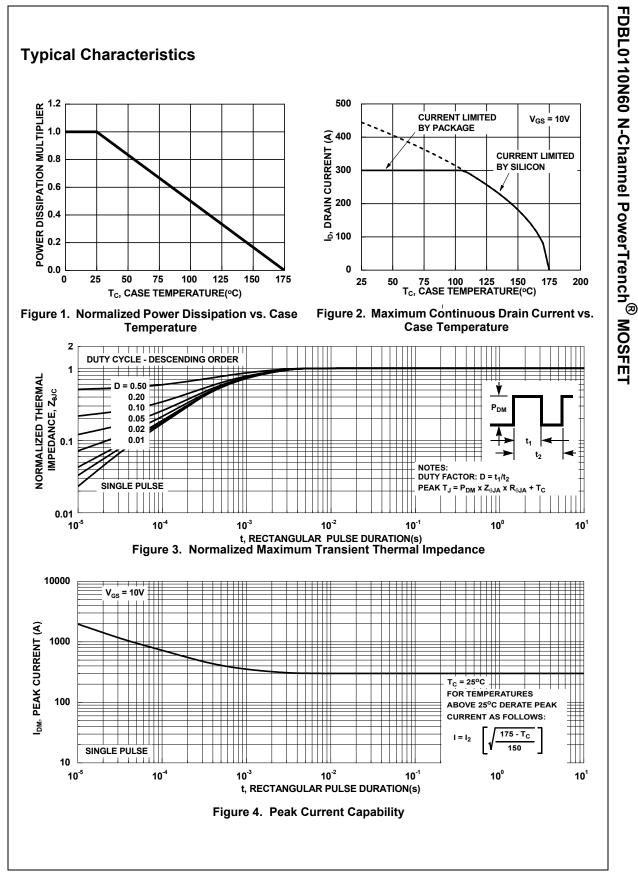
Package Marking and Ordering Information

Device Marking	Device	Package			
FDBL0110N60	FDBL0110N60	MO-299A	-	-	-

Off Cha B _{VDSS} I _{DSS}		163	Conditions	Min.	Тур.	Max.	Units
	racteristics						
	Drain-to-Source Breakdown Voltage	I _D = 250μA, V	/ _{GS} = 0V	60	-	-	V
DSS		V _{DS} = 60V		-	-	1	μA
	Drain-to-Source Leakage Current	$V_{GS} = 0V$	T _J = 175 ^o C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	V_{GS} = ±20V		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I		2.0	3.0	4.0	V
	Drain to Source On Desistance	I _D = 80A,	T _J = 25 ^o C	-	0.85	1.1	mΩ
R _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10V	T _J = 175 ^o C (Note 4) -	1.5	2.2	mΩ
-	c Characteristics			1	1		
C _{iss}	Input Capacitance	V _{DS} = 30V, \	$l_{00} = 0 V$	-	13650	-	pF
C _{oss}	Output Capacitance	-f = 1MHz	GS OV,	-	3375	-	pF
C _{rss}	Reverse Transfer Capacitance			-	255	-	pF
R _g	Gate Resistance	f = 1MHz		-	2.3	-	Ω
	Total Gate Charge at 10V	$V_{GS} = 0$ to 1	0V V _{DD} = 48V	-	170	220	nC
ג ק _(ToT)							
Q _{g(ToT)} Q _{g(th)}	Threshold Gate Charge	V _{GS} = 0 to 2'	V I _D = 80A	-	24	32	nC
Q _{g(ToT)} Q _{g(th)} Q _{gs} Q _{gd}	Threshold Gate Charge Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge ng Characteristics	V _{GS} = 0 to 2'	V I _D = 80A	-	24 56 24	32 - -	nC nC nC
Q _{g(ToT)} Q _{g(th)} Q _{gs} Q _{gd} Switchin	Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge	V _{GS} = 0 to 2 ¹	V I _D = 80A	- - -	56	32 - - 137 -	nC
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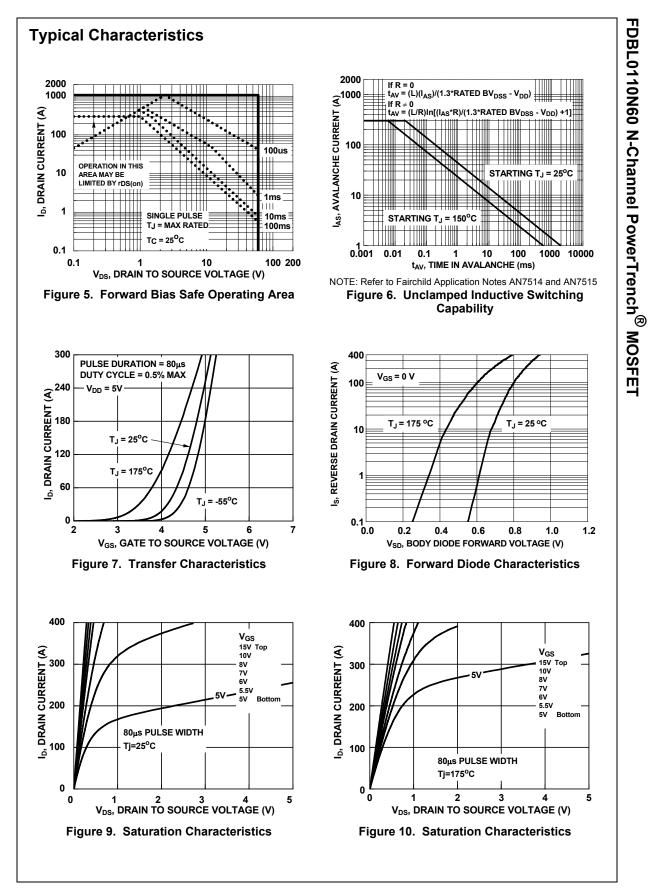
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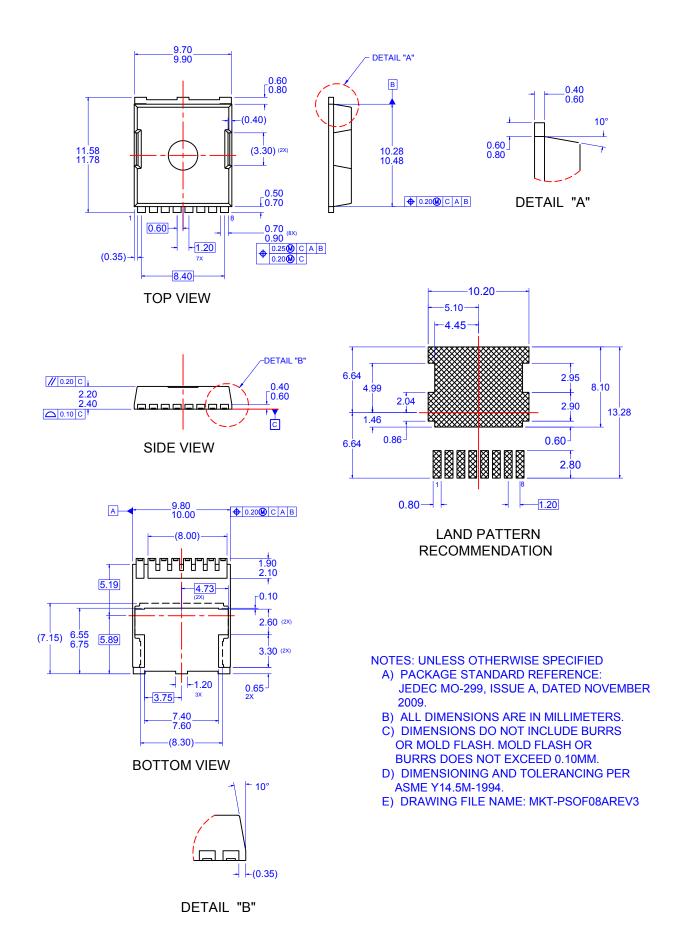


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